



March 10th, 2017

PCN20170310-1

Process Change Notification (PCN)

Due to a recent decline in vendor quality, Silicon Power has moved the “ThinPak Lidding” process in-house (Bldg.283). The process (Vacuum Furnace w/formic acid reflow) used to attach the lids has not changed but is now more closely monitored for quality assurance. This document serves as formal notification that Silicon Power Corporation is initiating this change to the products listed in Table 1.0.

The current pre-change inventory will be shipped on 3/15/2017.

Table 1.0 Products scheduled for Process Change

Silicon Power Part Number	Type of Change	Current Pre-Change Inventory	Future Part Number Following Change	Expected Realization of Change
CCSTA53N30A10	Location/vendor performing ThinPak Lidding operation	735	No Change	4/17/17

Respectfully,

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